

CERAMIC DIP 34, 50.8x50.8

CASE 125BK ISSUE O

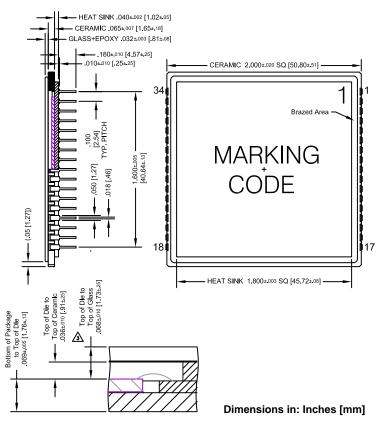
DATE 03 JUL 2014

NOTES:

- 1. Center of Active Image is at (+.046, +.078)mm with respect to Center of Package at (0,0).
- Die is visually aligned within 1 degree of any package cavity edge.
 Cover glass placement not to overhang from outside edges of the
- package

GLASS: SQ. 1.900±003 [48.26±08] APERTURE: SQ. 1.520±.010 [38.60±.25] = 34 Center of Active Image See Note 1. 1.002±.015 [25.45±.38] Center of Image (.050 [1.27]) **□** 0.002* 2.010±.020 [51.05±.51] 010^{+002}_{002} 25^{+05}_{05}

SHOWN WITH SEALED COVER GLASS



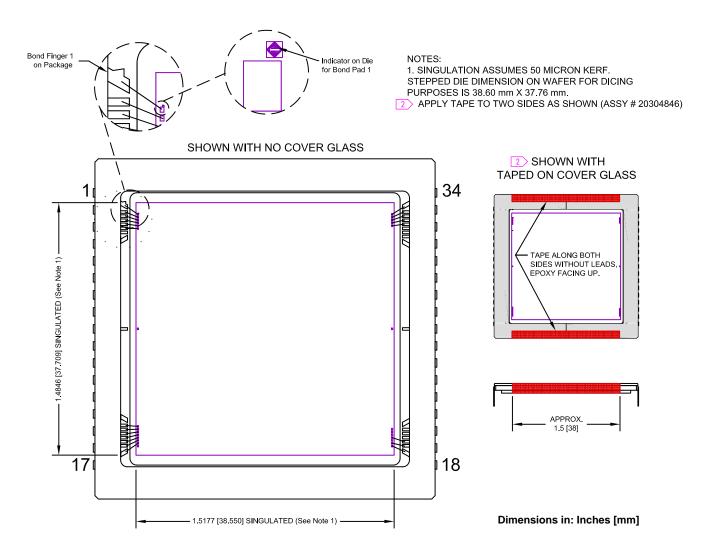
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